



## DPAK3 6.10x6.54x2.29, 4.57P CASE 369AS **ISSUE B**

**DATE 20 DEC 2023** 

- NOTES: UNLESS OTHERWISE SPECIFIED

  A) THIS PACKAGE CONFORMS TO JEDEC, TO-252, ISSUE F, VARIATION AA.

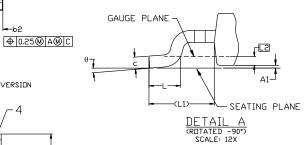
  B) ALL DIMENSIONS ARE IN MILLIMETERS.

  C) DIMENSIONING AND TOLERANCING PER

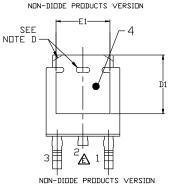
  - מו

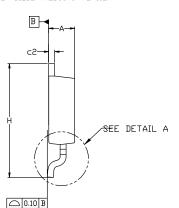
A

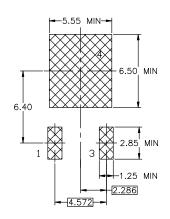
- F)
- DIMENSIONING AND TOLERANCING PER
  ASME Y14.5M-2018.
  SUPPLIER DEPENDENT MOLD LOCKING HOLES OR CHAMFERED
  CORNERS OR EDGE PROTRUSION.
  FOR DIGDE PRODUCTS, L4 IS 0.25 MM MAX PLASTIC BODY
  STUB WITHOUT CENTER LEAD.
  DIMENSIONS ARE EXCLUSIVE OF BURRS,
  MOLD FLASH AND TIE BAR EXTRUSIONS.
  LAND PATTERN RECOMMENDATION IS BASED ON IPC7351A STD
  T0228P991X239-3N.



DIM	MILLIMETERS			
DIN	MIN.	N□M.	MAX.	
Α	2.18	2.29	2.39	
A1	0.00	-	0.127	
b	0.64	0.77	0.89	
b2	0.76	0.95	1.14	
b3	5.21	5.34	5.46	
C	0.45	0.53	0.61	
c2	0.45	0.52	0.58	
D	5.97	6.10	6.22	
D1	5.21			
Ε	6.35	6.54	6.73	
E1	4.32			
е	5'586 B2C			
e1	4.572 BSC			
Н	9.40	9.91	10.41	
L	1.40	1.59	1.78	
L1	2.90 REF			
L2	0.51 BSC			
L3	0.89	1.08	1.27	
L4			1.02	
θ	0°		10°	







## LAND PATTERN RECOMMENDATION

\*FOR ADDITIONAL INFORMATION ON DUR
PB-FREE STRATEGY AND SOLDERING DETAILS,
PLEASE DOWNLOAD THE ON SEMICONDUCTOR
SOLDERING AND MOUNTING TECHNIQUES
REFERENCE MANUAL, SOLDERRM/D.

## **GENERIC MARKING DIAGRAM\***

XXXXXX XXXXXX AYWWZZ

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "=", may or may not be present. Some products may not follow the Generic Marking.

XXXX = Specific Device Code

= Assembly Location Α

Υ

= Work Week WW

ZZ = Assembly Lot Code

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DESCRIPTION: DPAK3 6.10x6.54x2.29, 4.5	7D	PAGE 1 OF 1

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